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FSB50825A / FSB50825AT Motion SPM[®] 5 Series

Features

- UL Certified No. E209204 (UL1557)
- 250 V $R_{DS(on)}$ = 0.45 $\Omega(Max)$ FRFET MOSFET 3-Phase Inverter with Gate Drivers and Protection
- · Built-in Bootstrap Diodes Simplify PCB Layout
- Separate Open-Source Pins from Low-Side MOSFETs for Three-Phase Current-Sensing
- Active-HIGH Interface, Works with 3.3 / 5 V Logic, Schmitt-trigger Input
- Optimized for Low Electromagnetic Interference
- HVIC Temperature-Sensing Built-in for Temperature Monitoring
- HVIC for Gate Driving and Under-Voltage Protection
- Isolation Rating: 1500 Vrms / 1 min.
- RoHS Compliant

Applications

SDE

 3-Phase Inverter Driver for Sm. P. er AC Motor Drives

Related Source

- <u>RD-FSB50450A Reference Design for Motion SPM 5</u> <u>Series Ver.2</u>
- <u>AN-9082 Motion SPM5 Series</u> <u>al Performance</u> <u>by Contact Pressure</u>
- <u>AN-9080 User's Guir' Jor Mou SP</u> <u>5 Series V2</u>

General Desc jot.

an uvanced Motion SPM® 5 The FSB506 A/AT Ily-featured, high-performance module, via a inv rou, it su AC Induction, BLDC and PMSM modules integrate optimized gate drive of otc t, bu, in MUSFET. (FREET® tech ology) to minimize EN and osses, while also providing multiple on-module prote tion features including under-voltage lockouts and thermal nonitoring. The outlinin high-speed HVIC requires only a single supply voltage and translates the incoming iogic-level gate inputs to the high-voltage, high-current drive signals required to properly drive the module's internal MOSFETs. Separate open-source MOSFET terminals are available each phase to support the widest variety of control algorithm.s



FSB50825AT

Package Marking & Ordering Information

Device Marking	Device	Package	Reel Size	Packing Type	Quantity
FSB50825A	FSB50825A	SPM5P-023	-	Rail	15
FSB50825AT	FSB50825AT	SPM5N-023	-	Rail	15

FSB50825A

October 2016

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Absolute Maximum Ratings

Inverter Part (each MOSFET unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V _{DSS}	Drain-Source Voltage of Each MOSFET		250	V
*I _{D 25}	Each MOSFET Drain Current, Continuous	T _C = 25°C	3.6	A
*I _{D 80}	Each MOSFET Drain Current, Continuous	T _C = 80°C	2.7	А
*I _{DP}	Each MOSFET Drain Current, Peak	T _C = 25°C, PW < 100 μs	9.0	A
*I _{DRMS}	Each MOSFET Drain Current, Rms	T _C = 80°C, F _{PWM} < 20 kHz	1.9	A _{rms}
*P _D	Maximum Power Dissipation	T_{C} = 25°C, For Each MOSFET	14.2	W

Control Part (each HVIC unless otherwise specified.)

Symbol	Parameter	Conditions	Ra. g	Unit
V _{CC}	Control Supply Voltage	Applied Between V _{CC} and COM	20	l V
V _{BS}	High-side Bias Voltage	Applied Between $\rm V_B$ and $\rm V_S$		
V _{IN}	Input Signal Voltage	Applied Between IN anc. OM	-L -V _{CC} - 0.3	V

Bootstrap Diode Part (each bootstrap diode unless otherwise spec

Symbol	Parameter	on tions Rating Unit
V _{RRMB}	Maximum Repetitive Reverse Voltage	V V Uc?
* I _{FB}	Forward Current	$T_{C} = 2$ γ 0.5 A
* I _{FPB}	Forward Current (Peak)	= 25°C, Under Ans Pulse Width 1.5 A

Thermal Resistance

Thermal Re	esistance		MMEYOUNE	0	
Symbol		Parame.	Conditions	Rating	Unit
$R_{ ext{ heta}JC}$, ¹	se Thinal Resistance	Each MOSFET uniter inverter Oper- ating Condition (1st Note 1)	8.8	°C/W
To†~~~'st、		NO, CO	THE		

To*	∵⁄st∖
107	SI

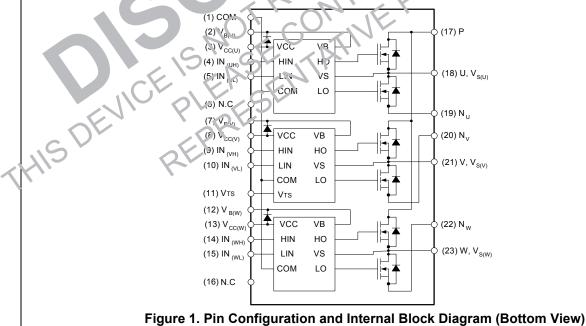
אר איז	Parameter	Conditions	Rating	Unit
TJ	Opera'ing Junction Ter perature		-40 ~ 150	°C
JJIG	Storage Temparature		-40 ~ 125	°C
VISO	Isolation Voltage	60 Hz, Sinusoidal, 1 Minute, Con- nect Pins to Heat Sink Plate	1500	V _{rms}

1st Notes:

1. For the measurement point of case temperature T_{C} , please refer to Figure 4.

2. Marking "*" is calculation value or design factor.

Pin Number	Pin Name	Pin Description
1	COM	IC Common Supply Ground
2	V _{B(U)}	Bias Voltage for U-Phase High-Side MOSFET Driving
3	V _{CC(U)}	Bias Voltage for U-Phase IC and Low-Side MOSFET Driving
4	IN _(UH)	Signal Input for U-Phase High-Side
5	IN _(UL)	Signal Input for U-Phase Low-Side
6	N.C	No Connection
7	V _{B(V)}	Bias Voltage for V-Phase High Side MOSFET Driving
8	V _{CC(V)}	Bias Voltage for V-Phase IC and Low Side MOSFET Driving
9	IN _(VH)	Signal Input for V-Phase High-Side
10	IN _(VL)	Signal Input for V-Phase Low-Side
11	V _{TS}	Output for HVIC Temperature Sensing
12	V _{B(W)}	Bias Voltage for W-Phase High-Side MOSFET Driv
13	V _{CC(W)}	Bias Voltage for W-Phase IC and Low-Side OSFET iving
14	IN _(WH)	Signal Input for W-Phase High-Side
15	IN _(WL)	Signal Input for W-Phase Low-Sit
16	N.C	No Connection
17	Р	Positive DC-Link Inc
18	U, V _{S(U)}	Output for U-PI ve & Bia Voltage Lound for High-Side MC FE i Driving
19	NU	Negative Link out for Chase
20	N _V	Nerrowing D. Lun. for V-Phase
21	V, V _{S(V)}	Jutput V-I se & Bias Voitage Ground for High-Side MOSFET Driving
22	N,	legative C-Link Input in N-Phase
23	W S(W)	C. or W Prase à Bias Vc tage Ground fo High-Side MOSFET Driving





3. Source terminal of each low-side MOSFET is not connected to supply ground or bias voltage ground inside Motion SPM[®] 5 product. External connections should be made as indicated in Figure 3.

FSB50825A / FSB50825AT Motion SPM® 5 Series

Electrical Characteristics	$T_J = 25^{\circ}C$, $V_{CC} = V_{BS} = 15 V$ unless otherwise specified.)
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Inverter Part (each MOSFET unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
BV _{DSS}	Drain - Source Breakdown Voltage	V _{IN} = 0 V, I _D = 1 mA (2nd Note 1)	250	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{IN} = 0 V, V _{DS} = 250 V	-	-	1	mA
R _{DS(on)}	Static Drain - Source Turn-On Resistance	V _{CC} = V _{BS} = 15 V, V _{IN} = 5 V, I _D = 2.0 A	-	0.33	0.45	Ω
V_{SD}	Drain - Source Diode Forward Voltage	$V_{CC} = V_{BS} = 15V, V_{IN} = 0 V, I_{D} = -2.0 A$	-	-	1.2	V
t _{ON}			-	ں ر		ns
t _{OFF}		$V_{PN} = 150 \text{ V}, V_{CC} = V_{BS} = 15 \text{ V}, I_D = 2.0 \text{ A}$		סי		ns
t _{rr}	Switching Times	$V_{IN} = 0 V \leftrightarrow 5 V$, Inductive Load L = 3 mH High- and Low-Side MOSFET Switching	-	15		.ns
E _{ON}		(2nd Note 2)		170		_,ıJ
E _{OFF}				10	77	μJ
RBSOA	Reverse Bias Safe Oper- ating Area	$V_{PN} = 200 \text{ V}, V_{CC} = V_{BS} = 15 \text{ V}, I_D = I_D \text{ V}_{DS} \text{ BV}_{DS}$ $T_J = 150^{\circ}\text{C}$ High- and Low-Side MOSF T S	2	Full	Square	

Control Part (each HVIC unless otherwise specified.)

Symbol	Parameter		Cc dition	103	Tyr	Max	Unit
I _{QCC}	Quiescent V _{CC} Current	V _{CC} = (V = 0	Applied Between V _{CC} and CC.4	2	Ur	200	μA
I _{QBS}	Quiescent V _{BS} Current	$V_{BS} \cdot \overline{5}V_{IN}$	$\begin{array}{c} \mbox{Applied Between V}_{\Gamma(U)} & \mbox{U}, \\ \mbox{V}_{S(V)} & \mbox{V}, \\ \mbox{V}_{B(W)} & \mbox{V} \end{array} \\ \end{array} $	0	-	100	μA
UV _{CCD}	Low-Side Unc -Vollage	Vool Jer-Voltage	Protection Detection Lovel	7.4	8.0	9.4	V
UV _{CCR}	Protection (F Ire 8)	V _{CC} Und +r-Voltage	Protection: Reset Level	8.0	8.9	9.8	V
UV _{BSD}	Hir -Side Unde '-'' ja	V _{DS} Under-Voltage	Protection Detection Level	7.4	8.0	9.4	V
UV _{BSR}	Prc . , ure 9)	V _{BS} Under-Voltage	Protection Reset Level	8.0	8.9	9.8	V
'TS	ing 'oltage Outout	V _{CC} = 15 V, T _{HMI} , =	: 25°C (2nd Note 4)	600	790	980	mV
ИН	ON Threshold Voltage	Logic HICH ⊾evel	Applied between IN and COM	-	-	2.9	V
	OFF Threshold Voltage	Logic LOW Level	Applied between IN and COM	0.8	-	-	V

Boctsire: Diode Part (each broustrap diode unless otherwise specified.)

Symool	Paramoter	Conditions	Min	Тур	Max	Unit
V _{FB}	Forward Vollage	I _F = 0.1 A, T _C = 25°C (2nd Note 5)	-	2.5	-	V
t _{rrB}	Reverse Recovery Time	I _F = 0.1 A, T _C = 25°C	-	80	-	ns

2nd Notes:

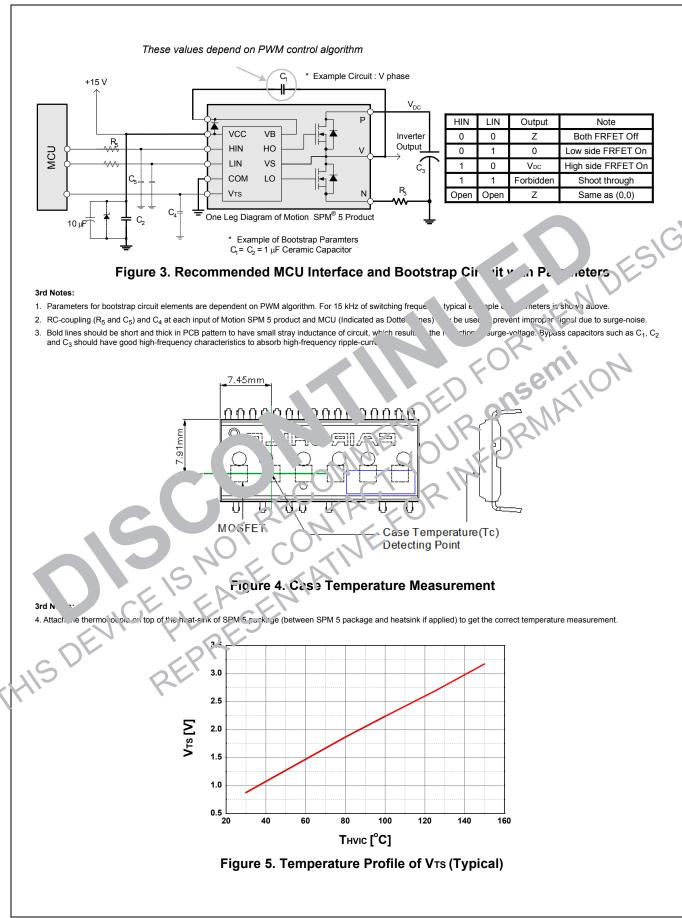
- 2. ton and toFF include the propagation delay of the internal drive IC. Listed values are measured at the laboratory test condition, and they can be different according to the field applications due to the effect of different printed circuit boards and wirings. Please see Figure 6 for the switching time definition with the switching test circuit of Figure 7.
- 3. The peak current and voltage of each MOSFET during the switching operation should be included in the Safe Operating Area (SOA). Please see Figure 7 for the RBSOA test circuit that is same as the switching test circuit.

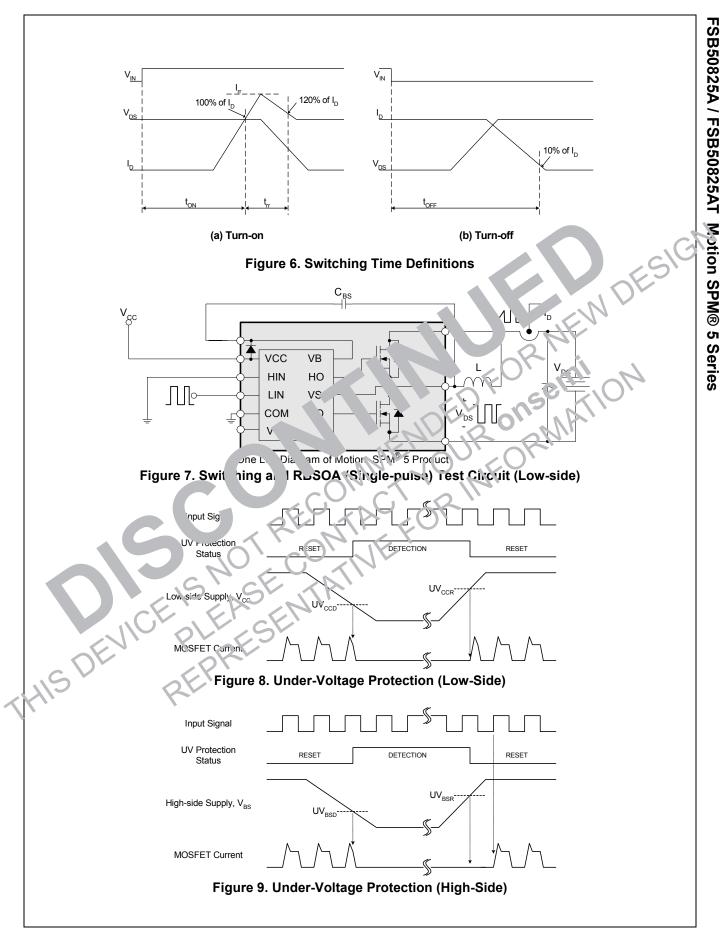
4. V_{ts} is only for sensing-temperature of module and cannot shutdown MOSFETs automatically.

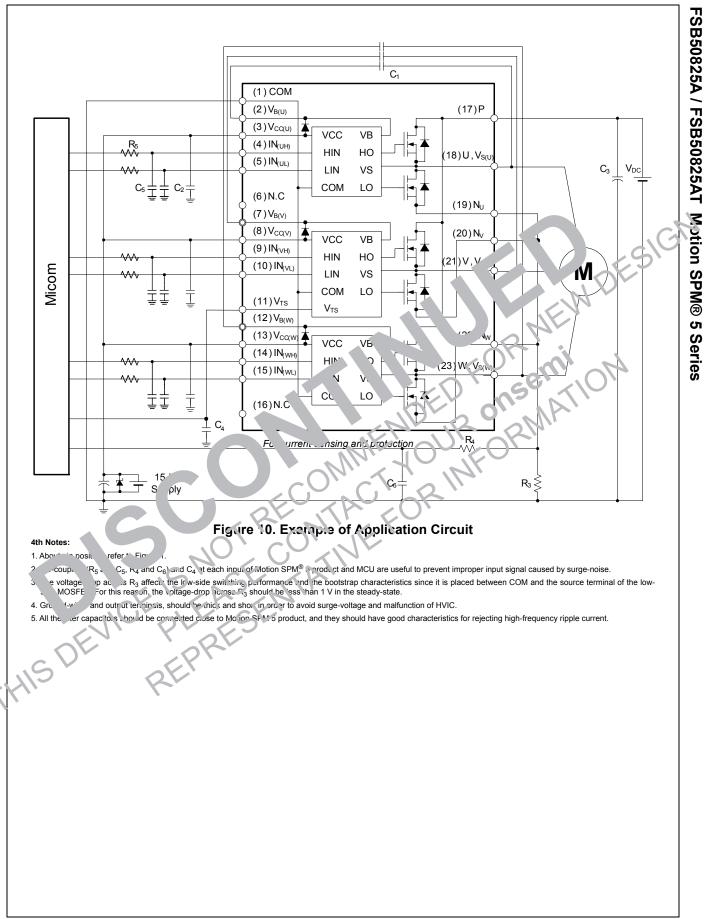
5. Built-in bootstrap diode includes around 15 Ω resistance characteristic. Please refer to Figure 2.

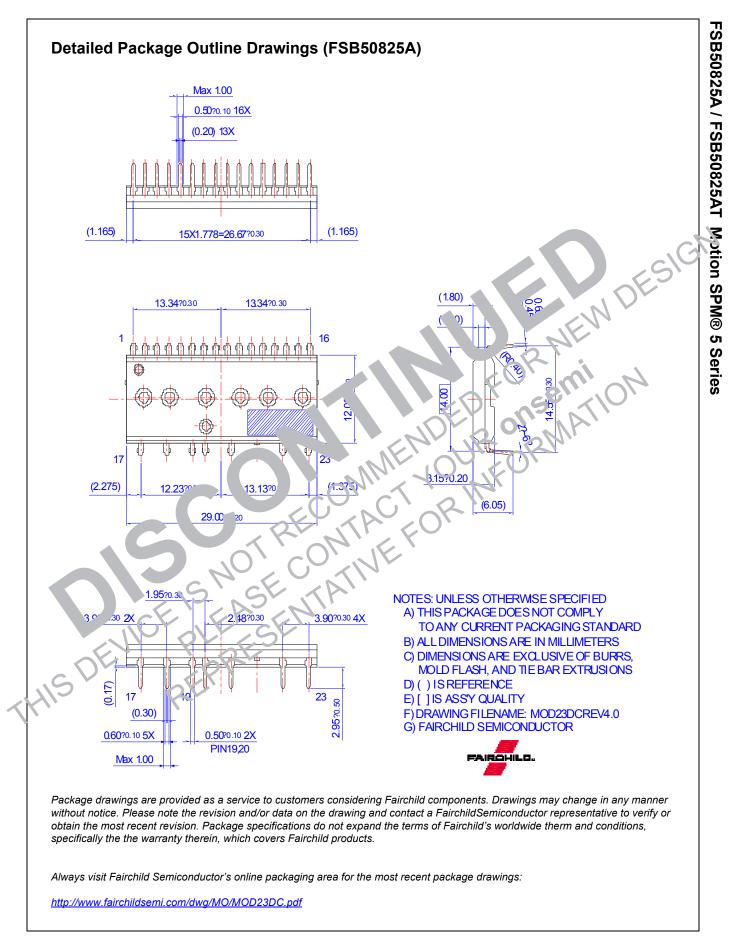
^{1.} BV_{DSS} is the absolute maximum voltage rating between drain and source terminal of each MOSFET inside Motion SPM[®] 5 product. V_{PN} should be sufficiently less than this value considering the effect of the stray inductance so that VPN should not exceed BVDSS in any case.

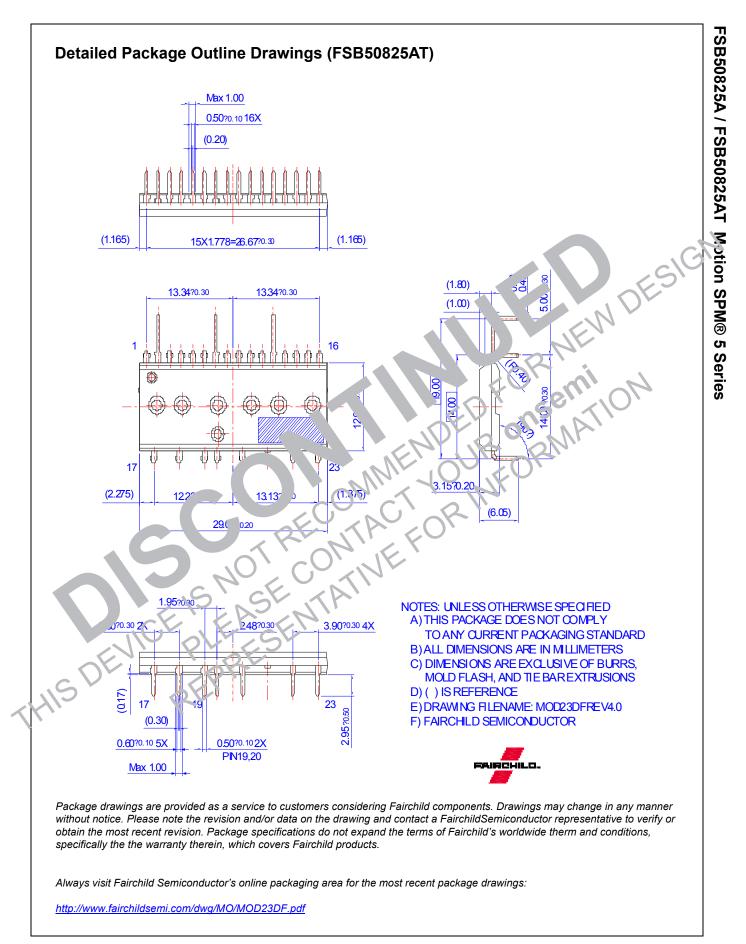
Recommended Operating Condition Conditions Symbol Parameter Min. Тур. Max. Unit Supply Voltage Applied Between P and N 150 200 V V_{PN} -Control Supply Voltage Applied Between V_{CC} and COM 13.5 16.5 V_{CC} 15.0 V 16.5 V High-Side Bias Voltage Applied Between V_B and V_S 13.5 15.0 V_{BS} Input ON Threshold Voltage V 3.0 - V_{CC} V_{IN(ON)} Applied Between IN and COM V_{IN(OFF)} Input OFF Threshold Voltage 0 0.6 V -Blanking Time for Preventing V_{CC} = V_{BS} = 13.5 ~ 16.5 V, $T_J\ \leq 150^\circ C$ 1.0 μS t_{dead} Arm-Short PWM Switching Frequency $T_{,l} \leq 150^{\circ}C$ 15 kHz f_{PWM} _ _ EW DESI Built-in Bootstrap Diode V_F-I_F Characteris 1.0 0.9 0.8 0.7 0.6 l₅ [A] 0.5 0.4 0.3 0.1 9 10 11 12 13 14 15 Tc=25°C Figure 2. Built-in Bootstrap Diode Characteristics (Typical) HIS DEVICE













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